








High Q RF Inductor



2022

LTCC PRODUCT PORTFOLIO

RF Component (Filter/Balun/Coupler/Diplexer)

				
BPF, LPF	Balun	Diplexer / Triplexer	Balanced BPF	Coupler

Ceramic Antenna

		
Chip Antenna	Patch Antenna	Active Antenna

RF Chip Inductor


High-Q Series

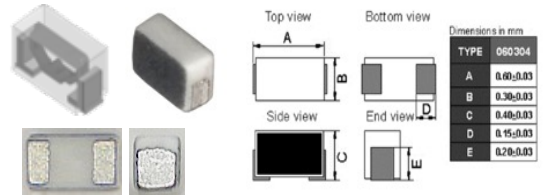
HIGH-Q RF INDUCTOR

High-Q RF Description

Thin-film inductor with L-shape terminations and optimization of inner coil structure using photolithography manufacturing

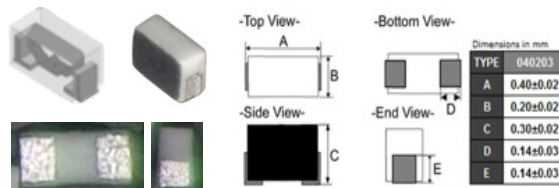
BSPQ00060304 Series

Size L x W x T (mm) **0.6 x 0.3 x 0.4**
 Inductance Range (nH) **0.6 - 22**
 Q @500MHz **Q ≥ 20**



BSPQ00040203 Series

Size L x W x T (mm) **0.4 x 0.2 x 0.3**
 Inductance Range (nH) **0.2 - 22**
 Q @500MHz **Q ≥ 13**



Features

- Photolithography Technology
- Higher Q
- Tight Tolerance
- Low RDC

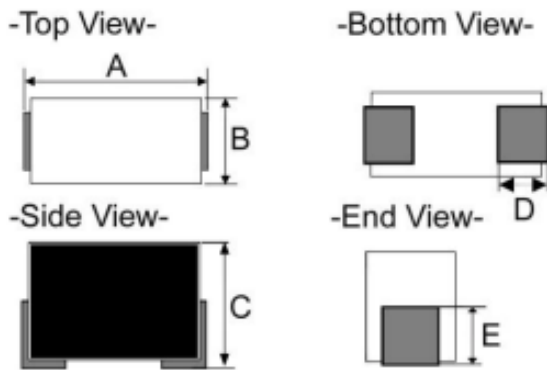
Application

- Mobile Phones
- RF Modules (FEM, WiFi, PA)

Series	Size L x W x H (mm)	Inductance Range (nH)	Q@500 (MHz) Min.	SRF Range (MHz) Min.	DCR Range (ohm) Max.	Rated current Range (mA) Max.	Status
BSPQ	0.6 x 0.3 x 0.4	0.6 - 22	20	3000 - 20000	0.04 - 0.82	250 - 1100	MP
BSPQ	0.4 x 0.2 x 0.3	0.2 - 10	14	3000 - 17000	0.01 - 2.26	140 - 1000	Sample

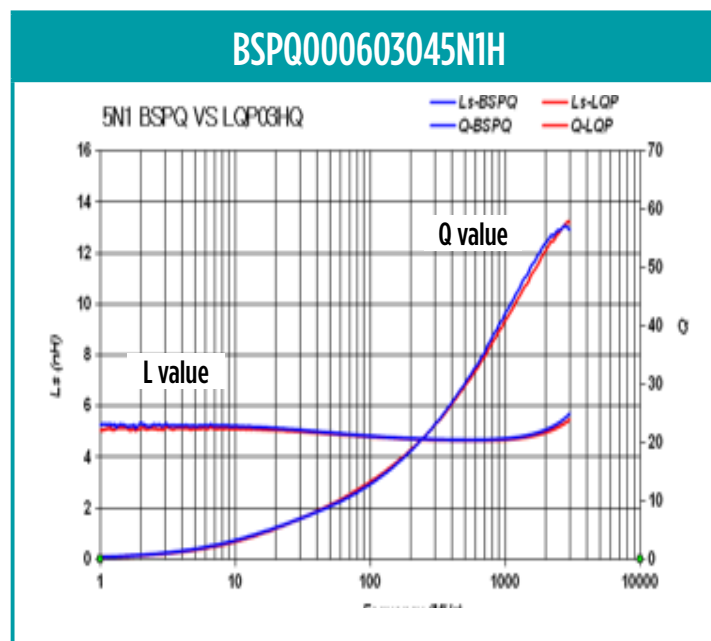
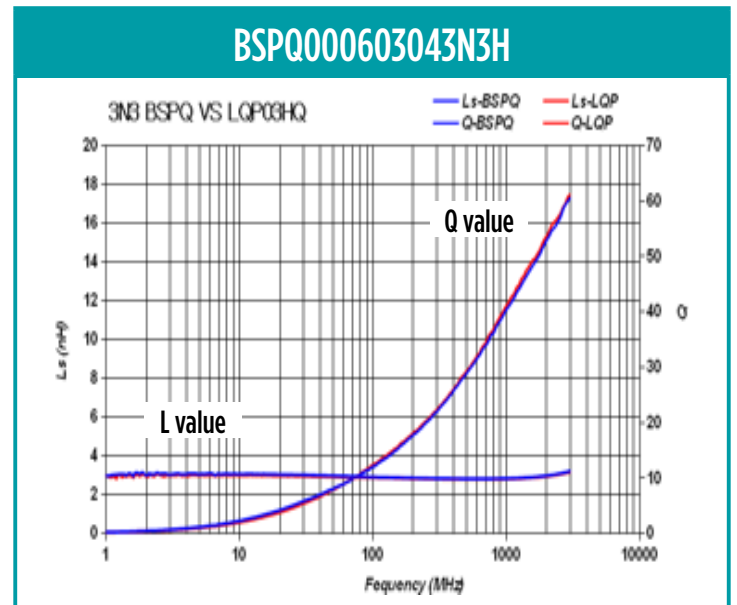
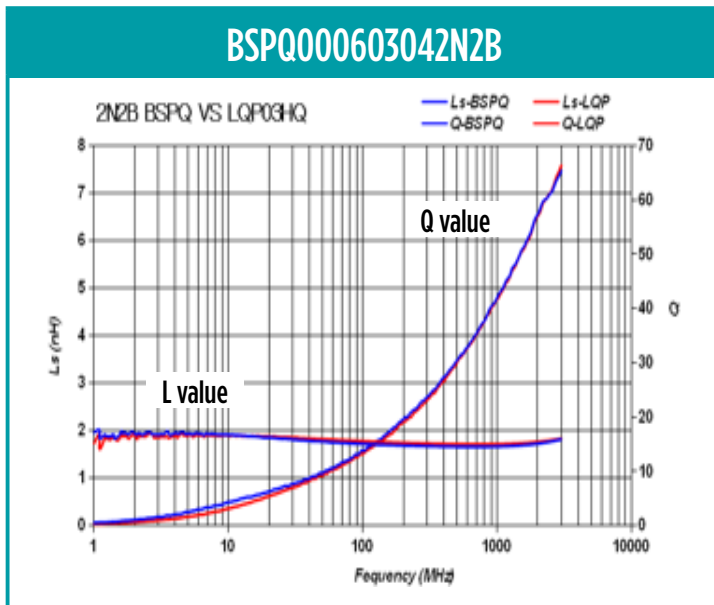
BSPQ00060304

• Dimensions



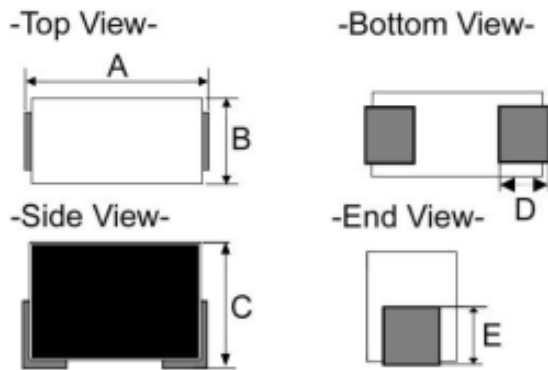
Type	060304
A	0.60±0.03
B	0.30±0.03
C	0.40±0.03
D	0.15±0.03
E	0.20±0.03

• Electrical Characteristics



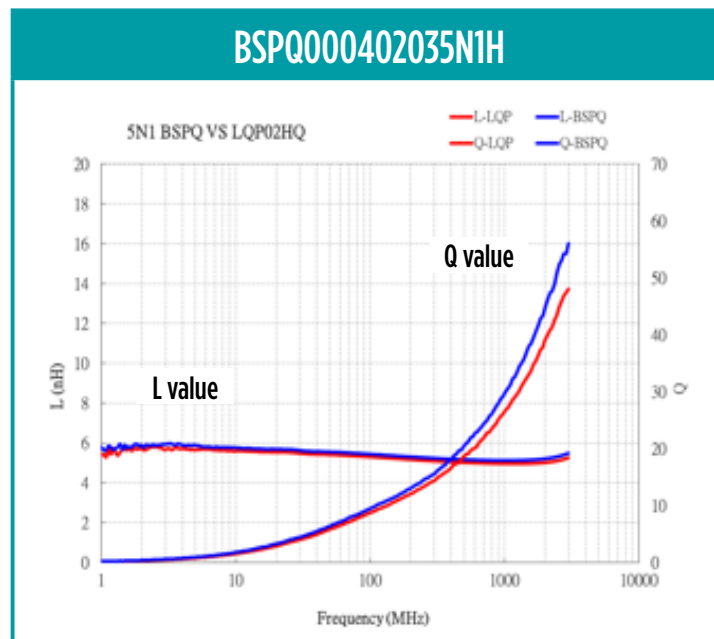
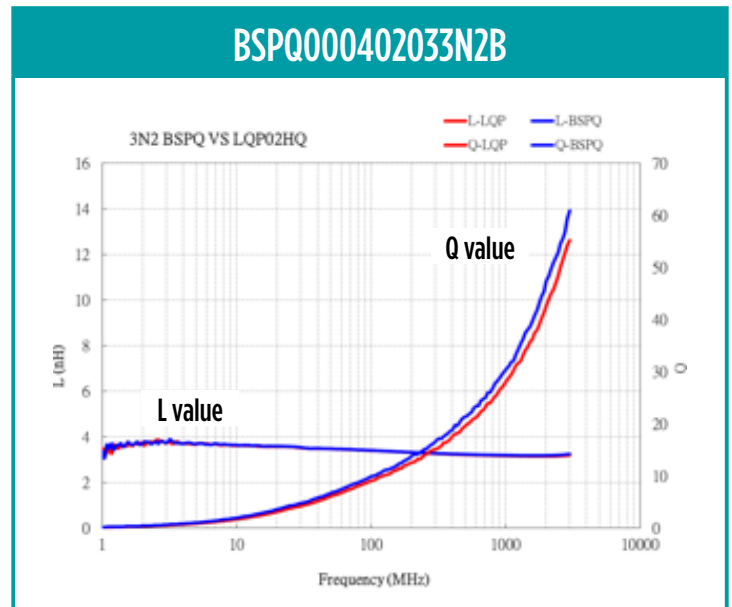
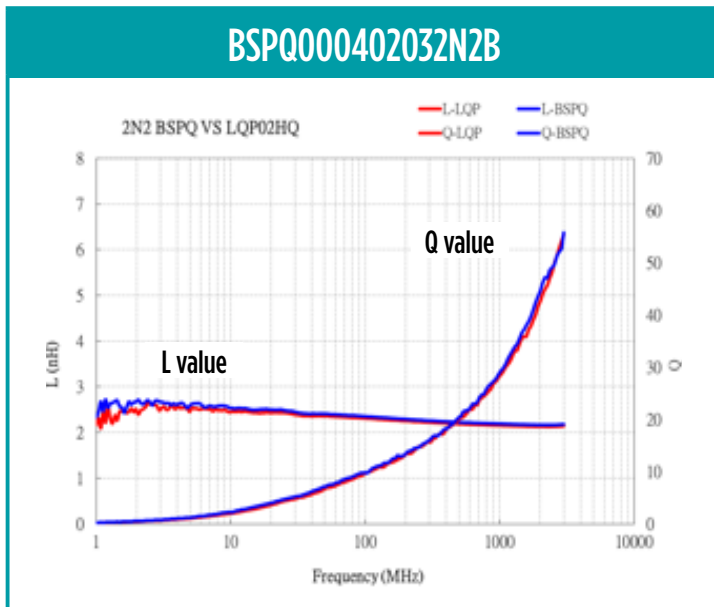
BSPQ00040203

• Dimensions

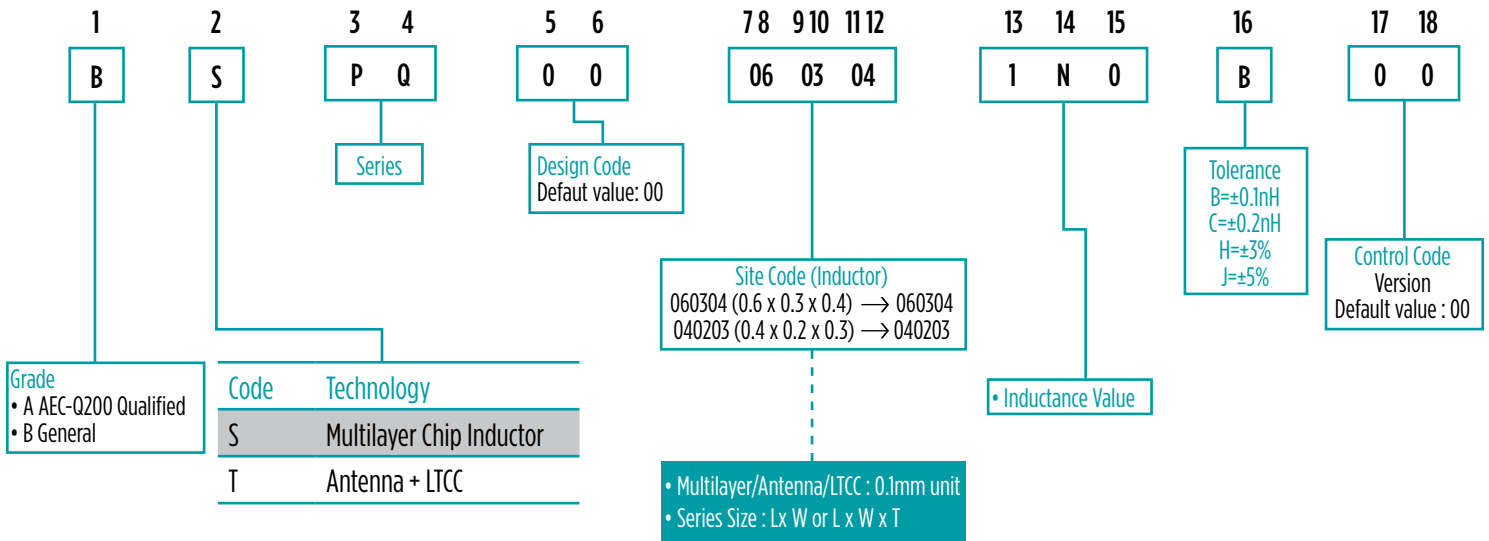


Type	040203
A	0.40±0.02
B	0.20±0.02
C	0.30±0.02
D	0.14±0.03
E	0.14±0.03

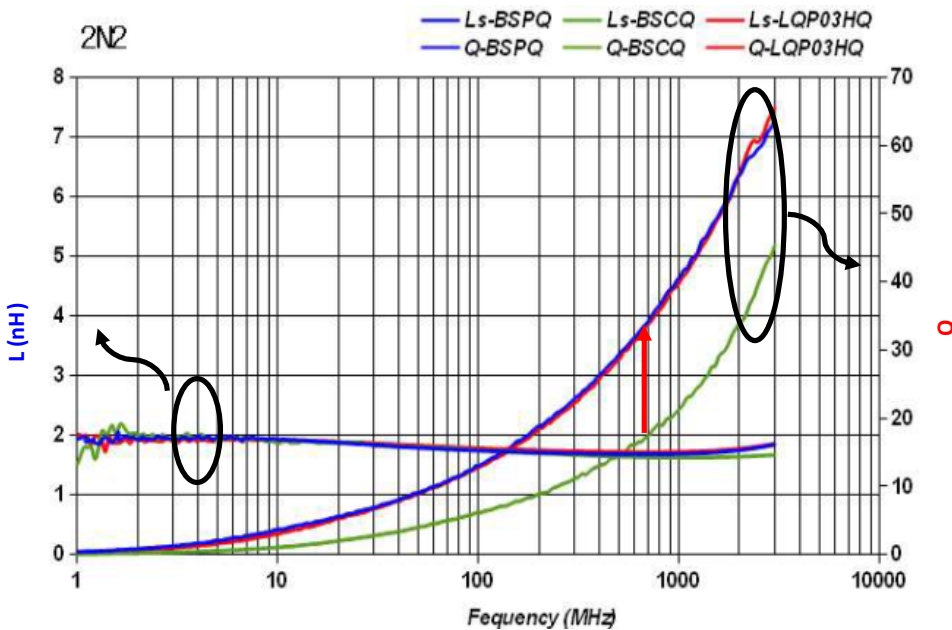
• Electrical Characteristics



CODING RULE



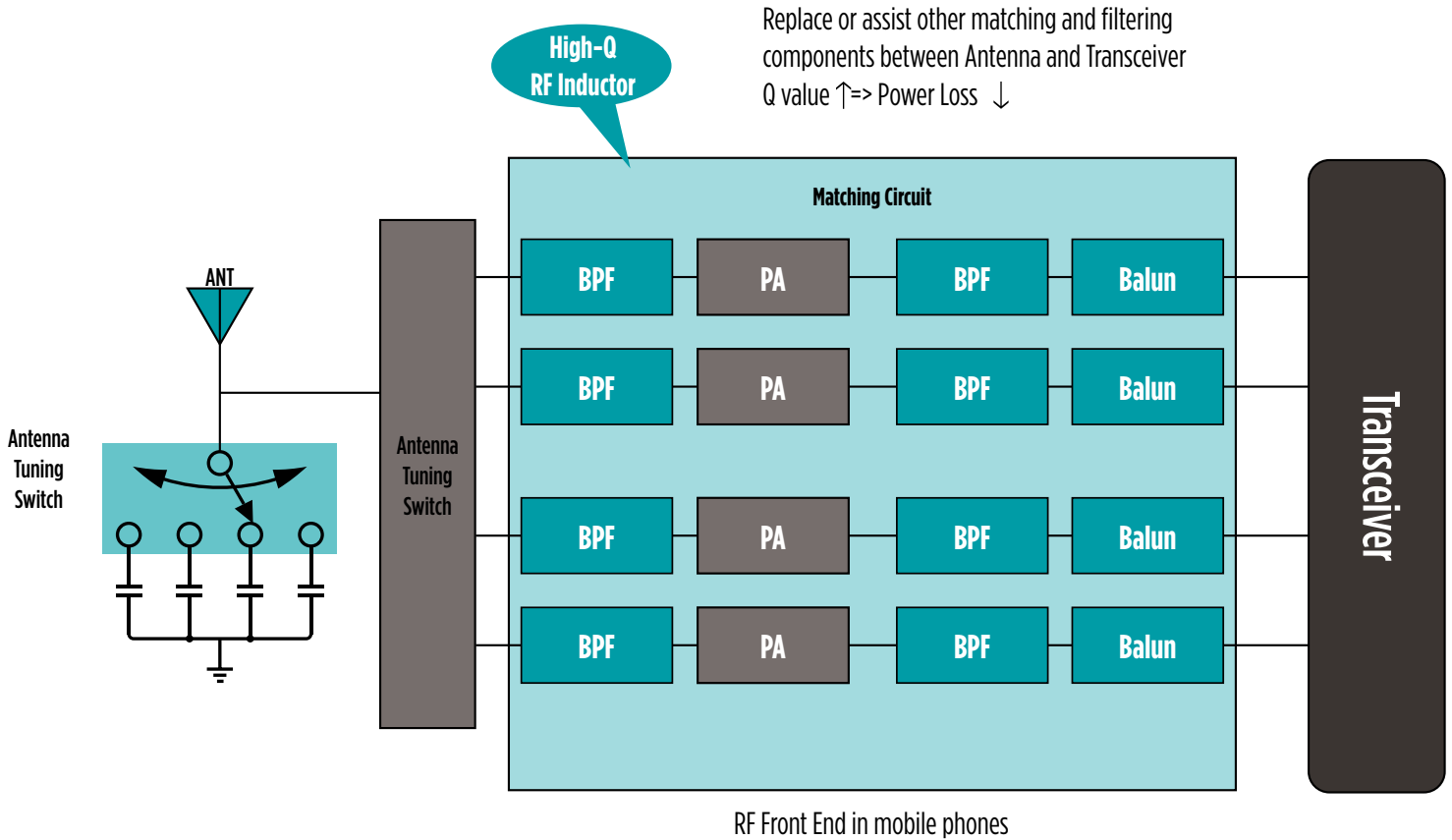
PERFORMANCE BENCHMARK



Based on the same inductance 2.2nH

- High-Q series has significant increase in Q value, compared to general series.
- Pulse (Chilisin) high-Q RF series is competitive with equivalent Q value to that of muRata.
- High-Q RF chip inductor series is produced with lithography process, has properties of Low ΔL , high Q value, and excellent rating current compared to general RF chip inductor.

HIGH-Q INDUCTORS ARE NECESSARY IN MODERN RF ARCHITECTURE



KEY APPLICATION

Focused Segments



Automotive Electronics



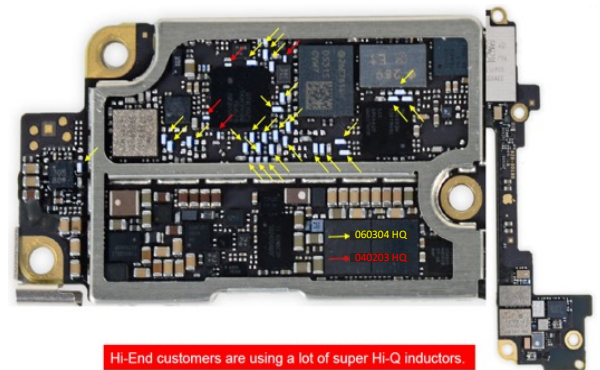
Networking / Server



Mobile Devices

Focused End Product

- **Wireless application:** Mobile phone, Wifi Netcom, Bluetooth, ront-End Modules, PA
- In **COST DOWN** RF-wound inductors (EMS foundry) (ODM dominates BOM), we can introduce our products to replace competitors products



High-end 5G and high-end wifi 6 mobile phone using high-Q-RF inductors:

The total design with RF inductors in the mobile phones in 100-110pcs/set and about 30% high-Q RF inductors

LTCC MANUFACTURING BASE



**Filter / Ceramic Antenna
Suzhou, China**

- Operation started: 2019
- Employee: 220
- Space: 6000 sqm
- Capacity: 130M pcs/M
- Quality Certificate
 - ISO14001: 2004
 - ISO9001: 2008
 - OHS18001: 2007



**Filter / Ceramic Antenna
Kaohsiung, Taiwan**

- Operation started: 1985
- Employee: 50
- Space: 1500 sqm
- Capacity: 20M pcs/M
- Quality Certificate
 - ISO14001: 2004
 - ISO9001: 2008
 - OHS18001: 2007
 - IATF16949: 2009



**Filter / High-Q RF Inductor
Taoyuan, Taiwan**

- Operation started: 1990
- Capacity:
 - 200M pcs/M for Inductor
 - 100M pcs/M for Filter
- Quality Certificate
 - ISO14001
 - OHS18001
 - IATF16949